

GP 1725
PATENT
Docket No.: P2D7D1-US

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Michelle White
Michelle White

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

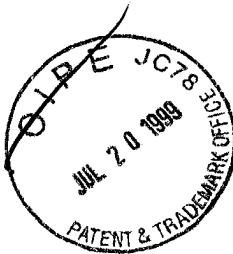
In the application of:

Igor Y. Khandros et al.

Application No.: 09/295,269

Filing Date: April 20, 1999

For: CONTACT STRUCTURE DEVICE FOR
INTERCONNECTIONS, INTERPOSER,
SEMICONDUCTOR ASSEMBLY AND
PACKAGE USING THE SAME AND
METHOD



Examiner: Not yet assigned

Group Art Unit: 1725

Assistant Commissioner for Patents
Washington, DC 20231

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Dear Sir:

Prior to examination of this application, Applicants respectfully request that the Examiner enter the following amendment.

IN THE TITLE

Please delete the current title "CONTACT STRUCTURE DEVICE FOR INTERCONNECTIONS, INTERPOSER, SEMICONDUCTOR ASSEMBLY AND PACKAGE USING THE SAME AND METHOD", and insert therefore --TIP STRUCTURES--.

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